

## CDBB520-G Thru. CDBB5100-G

**Reverse Voltage: 20 to 100 Volts**

**Forward Current: 5.0 Amp**

**RoHS Device**

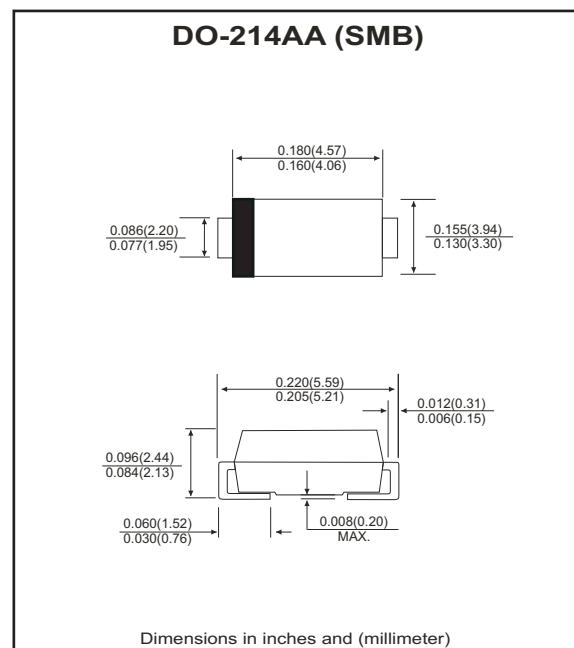


### Features

- Ideal for surface mount applications.
- For use in low voltage, high frequency inverters.
- Epitaxial construction.
- Metal-semiconductor junction with guarding.
- High current capability.
- Low forward voltage drop.

### Mechanical data

- Case: JEDEC DO-214AA, molded plastic.
- Terminals: Solderable per MIL-STD-750, method 2026.
- Polarity: Color band denotes cathode end.
- Approx. weight: 0.093 grams



### Maximum Ratings and Electrical Characteristics

Parameter	Symbol	CDBB 520-G	CDBB 530-G	CDBB 540-G	CDBB 550-G	CDBB 560-G	CDBB 580-G	CDBB 5100-G	Units					
Max. repetitive peak reverse voltage	V <sub>RRM</sub>	20	30	40	50	60	80	100	V					
Max. DC blocking voltage	V <sub>DC</sub>	20	30	40	50	60	80	100	V					
Max. RMS voltage	V <sub>RMS</sub>	14	21	28	35	42	56	70	V					
Peak surge forward current, 8.3ms single half sine-wave superimposed on rate load (JEDEC method)	I <sub>FSM</sub>	175							A					
Max. average forward rectified current at TL=90°C	I <sub>(AV)</sub>	5.0							A					
Max. instantaneous forward voltage at 5.0A DC @T <sub>c</sub> =100°C	V <sub>F</sub>	0.55		0.70					V					
Max. DC reverse current at T <sub>j</sub> =25°C rated DC blocking voltage T <sub>j</sub> =100°C	I <sub>R</sub>	0.5 20							mA					
Max. operating junction temperature	C <sub>J</sub>	300							°F					
Max. thermal resistance	R <sub>θJA</sub> R <sub>θJL</sub>	50 10							°C/W					
Max. operating junction temperature	T <sub>J</sub>	-55 to +125							°C					
Storage temperature	T <sub>STG</sub>	-55 to +150							°C					

Notes: 1. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.  
2. Thermal resistance junction to lead.

REV:A

# SMD Schottky Barrier Rectifiers

**Comchip**  
SMD Diode Specialist

## RATING AND CHARACTERISTIC CURVES (CDBB520-G thru CDBB5100-G)

Fig.1 - Forward Current Derating Curve

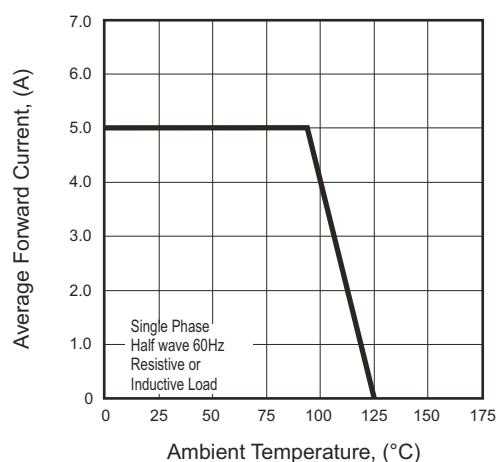


Fig.2 - Maximum Non-Repetitive Surge Current

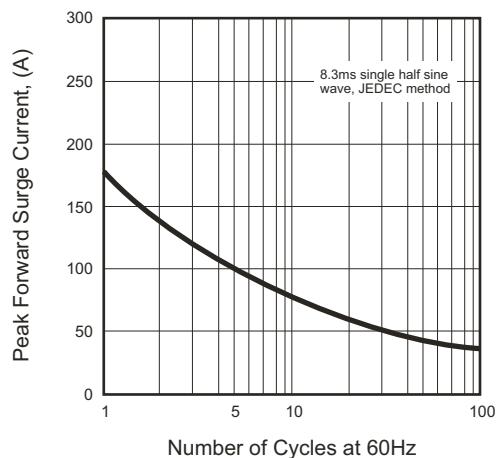


Fig.3 - Typical Instantaneous Forward Characteristics

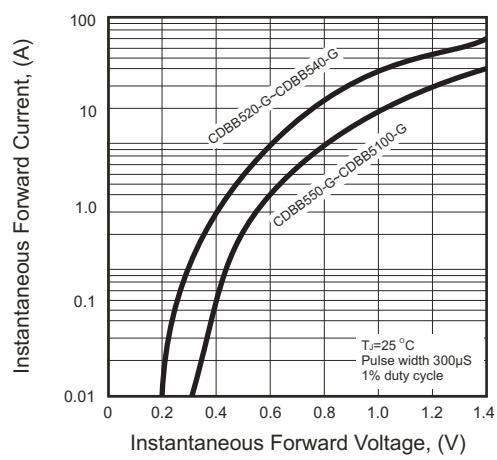


Fig.4 - Typical Junction Capacitance

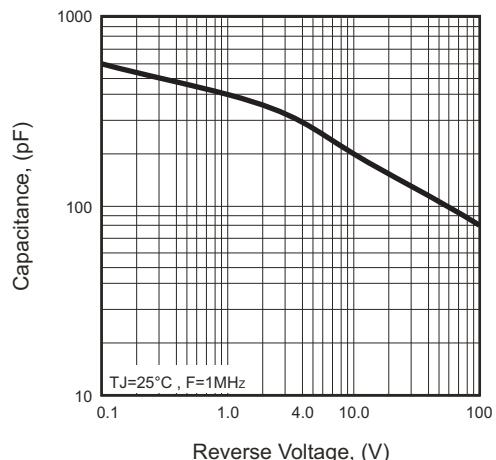
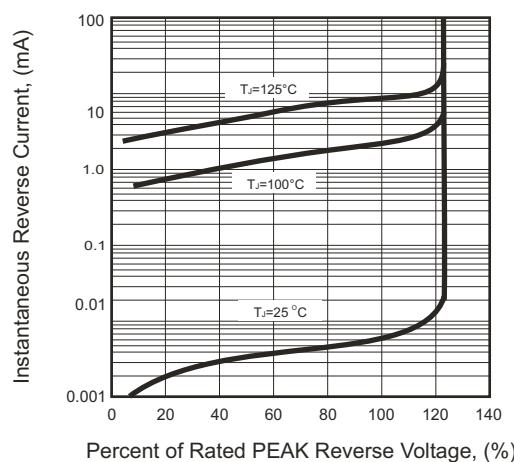
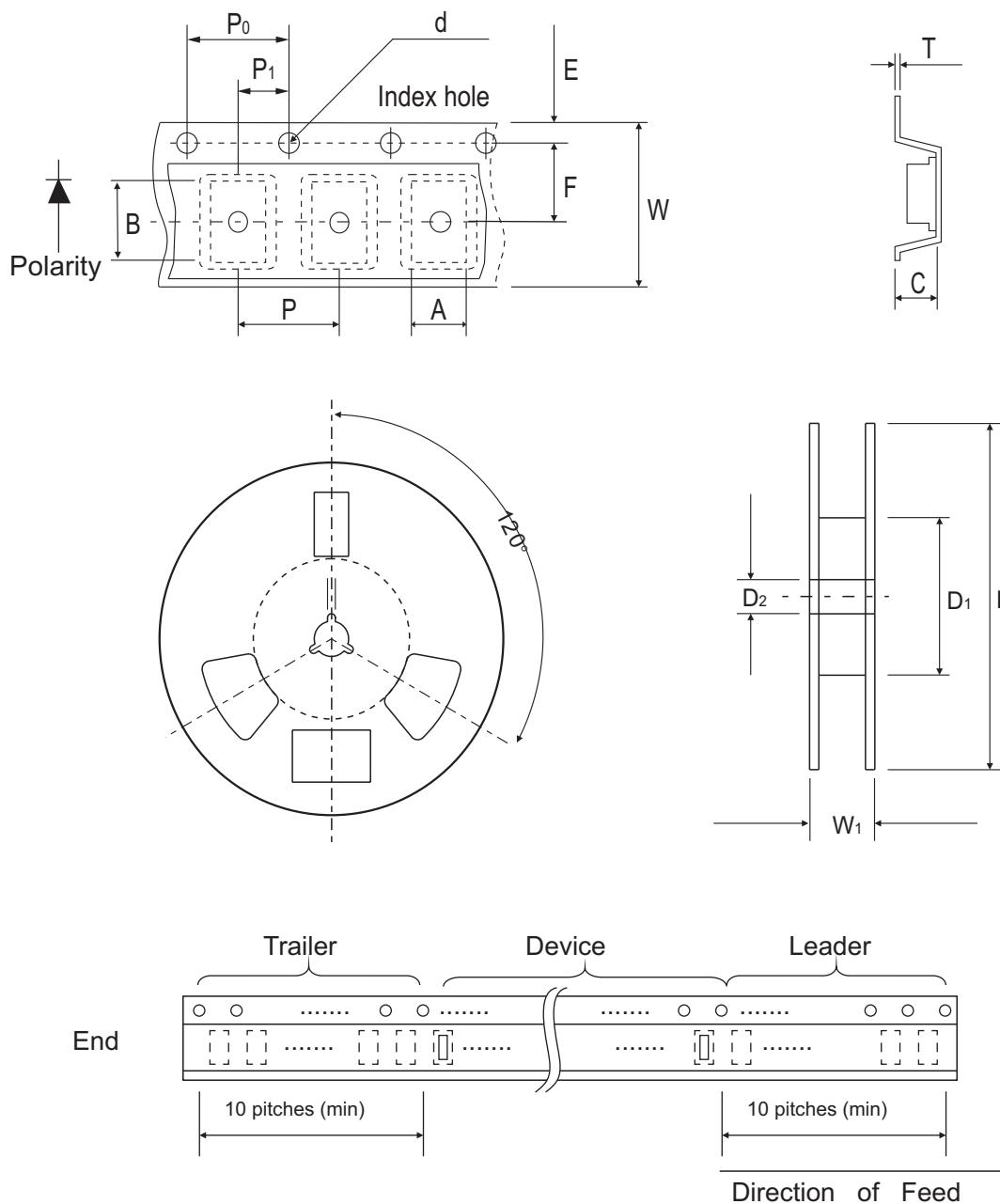


Fig.5 - Typical Reverse Characteristics



## Reel Taping Specification



DO-214AA (SMB)	SYMBOL	A	B	C	d	D	D1	D2
	(mm)	4.00 MAX.	5.90 MAX.	3.00 MAX.	$1.50 \pm 0.10$ DIA	$330 \pm 2.00$	50.0 MIN.	$13.50 \pm 1.0$
	(inch)	0.157 MAX.	0.232 MAX.	0.118 MAX.	$0.059 \pm 0.004$ DIA	$12.99 \pm 0.079$	1.969 MIN.	$0.531 \pm 0.039$

DO-214AA (SMB)	SYMBOL	E	F	P	$P_0$	$P_1$	T	W	W1
	(mm)	$1.75 \pm 0.10$	$5.50 \pm 0.05$	$8.00 \pm 0.10$	$4.00 \pm 0.10$	$2.00 \pm 0.05$	0.60 MAX	$12.0 \pm 0.30$	18.4 MAX.
	(inch)	$0.069 \pm 0.004$	$0.217 \pm 0.002$	$0.315 \pm 0.004$	$0.157 \pm 0.004$	$0.079 \pm 0.004$	$0.236 \pm 0.004$	$0.472 \pm 0.012$	0.724 MAX

## Marking Code

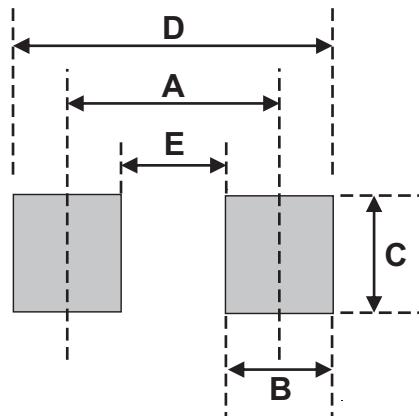
Part Number	Marking Code
CDBB520-G	SS52
CDBB530-G	SS53
CDBB540-G	SS54
CDBB550-G	SS55
CDBB560-G	SS56
CDBB580-G	SS58
CDBB5100-G	SS510



xxxxx = Product type marking code

## Suggested PAD Layout

SIZE	DO-214AA(SMB)	
	(mm)	(inch)
A	4.30	0.169
B	2.50	0.098
C	2.30	0.091
D	6.80	0.268
E	1.80	0.071



## Standard Packaging

Case Type	REEL PACK	
	REEL ( pcs )	Reel Size (inch)
DO-214AA (SMB)	3,000	13